Next Page OMB Control Number: 0694-0143 Expiration Date: March 31, 2022

REQUEST FOR PUBLIC COMMENT: RISKS IN THE SEMICONDUCTOR PRODUCT SUPPLY CHAIN

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nges currently facing the semiconductor product supply chain. All comments are invited, with this form designed to facilitate submission of	
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23	oh 5) and purchasers of integrated circuits or related products (in Sections 6 through 8)
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Those submitting a form containing business confidential information will need to submit a non-confidential version of the same form that does not contain the business confidential information.

Organization Name	HUTOKiniton Coro,	GM MAC # MO1250017
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A. State	Michig 43	
Zip Code	n/kh	
Country	0.5 A	
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From the list below, identify your organization's primary and additional participation in the semiconductor product supply chain. Please mark all applicable rows.

	Segment	Participation
Integrated Circuit Design		97
Front End Fabrication		
Back End/Assembly Test/Packaging	Packaging	
:lectronic Manufacturing	B. Electronic Manufacturing Services / Printed Circuit Board Assembly	
IC Distributor		2
Equipment Supplier		S. N.
Material Supplier		
Electronic Component Supplier	pplier	Ş
ntermediate or End User	Intermediate or End User of Semiconductor Products	
Other	(specify here)	

Next Step:

Sections 2 through 5 of this form are intended to be filled out by organizations that have primary or additional participation in the following segments: Integrated Circuit Design, Front End Fabrication, Back End/Assembly Test/Packaging, Electronic Manufacturing Services / Printed Circuit Board Assembly, and IC distributor.

Sections 6 through 8 of this form are intended to be filled out by organizations that purchase integrated circuits.

If your organization's responses do not reasonably fit in the above sections, please provide comments in Section 9.

BURDEN ESTIMATE AND REQUEST FOR COMMENT

Public reporting burden for this collection of information is estimated to average 4 hours per response, including the time for reviewing instructions, searching existing data sources, gathering and maintaining the data needed, and completing and reviewing the collection of information. Send comments regarding this burden estimate or any other aspect of this collection of information to BIS Information Collection Officer, Room 6883, Bureau of Industry and Security, U.S. Department of Commerce, Washington, D.C. 20230, and to the Office of Management and Budget, Paperwork Reduction Project (OMB Control No. 0694-0143), Washington, D.C. 20503.

Use this space to provide any general comments that do not reasonably fit in other sections of the form. Please limit your response to the space available; supplemental information can be submitted as a separate attachment on regulations.gov. Pleise be advised that this survey does not apply to our Company,

That you A/V

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